



## 12-BIT 250-KSPS SERIAL CMOS SAMPLING ANALOG-TO-DIGITAL CONVERTER

### FEATURES

- 250-kHz Sampling Rate
- 4-V, 5-V, 10-V,  $\pm 3.33$ -V,  $\pm 5$ -V, and  $\pm 10$ -V Input Ranges
- 73-dB SINAD With 45-kHz Input
- $\pm 0.45$  LSB Max INL
- $\pm 0.45$  LSB Max DNL, 12-Bits No Missing Codes
- $\pm 1$  LSB Bipolar Zero Errors
- $\pm 0.4$  PPM/ $^{\circ}\text{C}$  Bipolar Zero Error Drift
- Six Specified Input Ranges
- SPI Compatible Serial Output with Daisy-Chain (TAG) Feature
- 5-V Supply
- Pin-Compatible With ADS7808 (Low Speed) and 16-Bit ADS8509/7809
- Uses Internal or External Reference
- 70-mW Typ Power Dissipation at 250 KSPS
- 20-Pin SO Package
- Simple DSP Interface

### APPLICATIONS

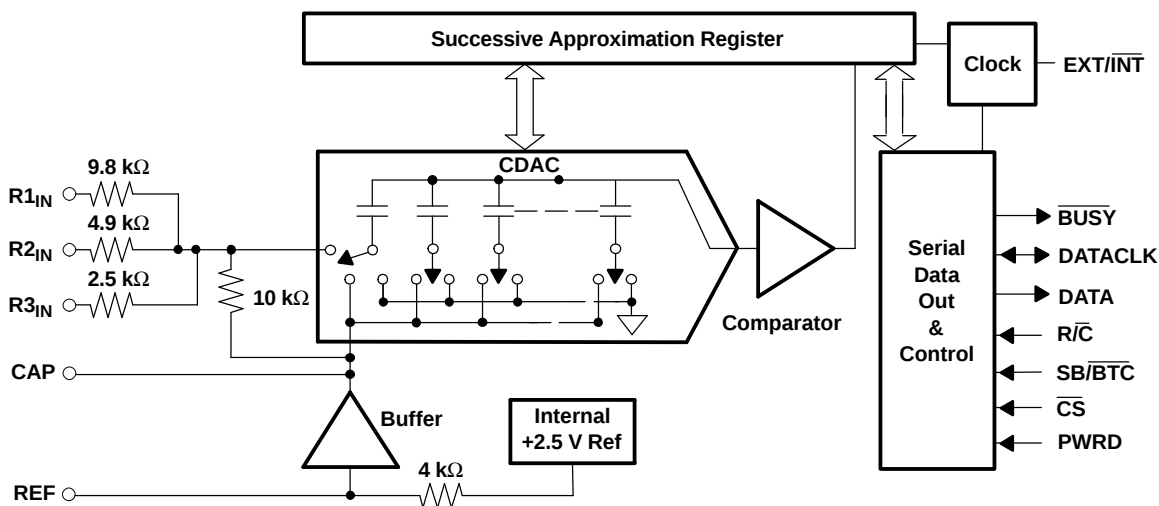
- Industrial Process Control
- Data Acquisition Systems
- Digital Signal Processing
- Medical Equipment
- Instrumentation

### DESCRIPTION

The ADS8508 is a complete 12-bit sampling analog-to-digital (A/D) converter using state-of-the-art CMOS structures. It contains a complete 12-bit, capacitor-based, successive approximation register (SAR) A/D converter with sample-and-hold, reference, clock, and a serial data interface. Data can be output using the internal clock or can be synchronized to an external data clock. The ADS8508 also provides an output synchronization pulse for ease of use with standard DSP processors.

The ADS8508 is specified at a 250-kHz sampling rate over the full temperature range. Precision resistors provide various input ranges including  $\pm 10$  V and 0 V to 5 V, while the innovative design allows operation from a single +5-V supply with power dissipation under 100 mW.

The ADS8508 is available in a 20-pin SO package, fully specified for operation over the industrial  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$  temperature range.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

# PACKAGE/ORDERING INFORMATION<sup>(1)</sup>

| PRODUCT   | MINIMUM<br>RELATIVE<br>ACCURACY<br>(LSB) | NO<br>MISSING<br>CODE | MINIMUM<br>SINAD<br>(dB) | SPECIFICATION<br>TEMPERATURE<br>RANGE | PACKAGE<br>LEAD | PACKAGE<br>DESIGNATOR | ORDERING<br>NUMBER | TRANSPORT<br>MEDIA, QTY |
|-----------|------------------------------------------|-----------------------|--------------------------|---------------------------------------|-----------------|-----------------------|--------------------|-------------------------|
| ADS8508IB | ±0.45                                    | 12                    | 72                       | -40°C to 85°C                         | SO-20           | DW                    | ADS8508IBDW        | Tube, 25                |
|           |                                          |                       |                          |                                       |                 |                       | ADS8508IBDWR       | Tape and Reel, 2000     |

(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at [www.ti.com](http://www.ti.com).

## ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

| ADS8508                           |                                      |                                                                |
|-----------------------------------|--------------------------------------|----------------------------------------------------------------|
| Analog inputs                     | R1 <sub>IN</sub>                     | ±25 V                                                          |
|                                   | R2 <sub>IN</sub>                     | ±25 V                                                          |
|                                   | R3 <sub>IN</sub>                     | ±25 V                                                          |
|                                   | CAP                                  | +V <sub>ANA</sub> + 0.3 V to AGND2 - 0.3 V                     |
|                                   | REF                                  | Indefinite short to AGND2, momentary short to V <sub>ANA</sub> |
| Ground voltage differences        | DGND, AGND2                          | ±0.3 V                                                         |
|                                   | V <sub>ANA</sub>                     | 6 V                                                            |
|                                   | V <sub>DIG</sub> to V <sub>ANA</sub> | 0.3 V                                                          |
|                                   | V <sub>DIG</sub>                     | 6 V                                                            |
| Digital inputs                    |                                      | -0.3 V to +V <sub>DIG</sub> + 0.3 V                            |
| Maximum junction temperature      |                                      | 165°C                                                          |
| Storage temperature range         |                                      | -65°C to 150°C                                                 |
| Internal power dissipation        |                                      | 700 mW                                                         |
| Lead temperature (soldering, 10s) |                                      | 260°C                                                          |

(1) All voltage values are with respect to network ground terminal.

## ELECTRICAL CHARACTERISTICS

At T<sub>A</sub> = -40°C to 85°C, f<sub>s</sub> = 250 kHz, V<sub>DIG</sub> = V<sub>ANA</sub> = 5 V, using internal reference and fixed resistors (See [Figure 28](#) and [Figure 29](#)) (unless otherwise specified)

| PARAMETER                       |                              | TEST CONDITIONS     | ADS8508IB |     |      | UNIT               |
|---------------------------------|------------------------------|---------------------|-----------|-----|------|--------------------|
|                                 |                              |                     | MIN       | TYP | MAX  |                    |
| Resolution                      |                              |                     |           |     | 12   | Bits               |
| <b>ANALOG INPUT</b>             |                              |                     |           |     |      |                    |
| Voltage ranges <sup>(1)</sup>   |                              |                     |           |     |      |                    |
| Impedance <sup>(1)</sup>        |                              |                     |           |     |      |                    |
| Capacitance                     |                              |                     |           | 50  |      | pF                 |
| <b>THROUGHPUT SPEED</b>         |                              |                     |           |     |      |                    |
| Conversion cycle                |                              | Acquire and convert |           |     | 4    | μs                 |
| Throughput rate                 |                              |                     | 250       |     |      | kHz                |
| <b>DC ACCURACY</b>              |                              |                     |           |     |      |                    |
| INL                             | Integral linearity error     |                     | -0.45     |     | 0.45 | LSB <sup>(2)</sup> |
| DNL                             | Differential linearity error |                     | -0.45     |     | 0.45 | LSB                |
| No missing codes                |                              |                     | 12        |     |      | Bits               |
| Transition noise <sup>(3)</sup> |                              |                     |           | 0.1 |      | LSB                |

(1) ±10 V, 0 V to 5 V, etc. (see [Table 3](#))

(2) LSB means least significant bit. For the ±10-V input range, one LSB is 4.88 mV.

(3) Typical rms noise at worst case transitions and temperatures.

## ELECTRICAL CHARACTERISTICS (continued)

At  $T_A = -40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ ,  $f_s = 250\text{ kHz}$ ,  $V_{\text{DIG}} = V_{\text{ANA}} = 5\text{ V}$ , using internal reference and fixed resistors (See [Figure 28](#) and [Figure 29](#)) (unless otherwise specified)

| PARAMETER                                                                        |                              | TEST CONDITIONS                              | ADS8508IB |                         |      | UNIT              |
|----------------------------------------------------------------------------------|------------------------------|----------------------------------------------|-----------|-------------------------|------|-------------------|
|                                                                                  |                              |                                              | MIN       | TYP                     | MAX  |                   |
| Full-scale error <sup>(4)(5)</sup>                                               | ±10 V range                  | Int. Ref. with 0.1% external fixed resistors | -0.5      |                         | 0.5  | %FS               |
|                                                                                  | All other ranges             |                                              | -0.5      |                         | 0.5  |                   |
| Full-scale error drift                                                           |                              | Int. Ref.                                    | ±7        |                         |      | ppm/°C            |
| Full-scale error <sup>(4)(5)</sup>                                               | ±10 V range                  | Ext. Ref. with 0.1% external fixed resistors | -0.5      |                         | 0.5  | %FS               |
|                                                                                  | All other ranges             |                                              | -0.5      |                         | 0.5  |                   |
| Full-scale error drift                                                           |                              | Ext. Ref.                                    | ±2        |                         |      | ppm/°C            |
| Bipolar zero error <sup>(4)</sup>                                                |                              |                                              | -1        |                         | 1    | mV                |
| Bipolar zero error drift                                                         |                              |                                              | ±0.4      |                         |      | ppm/°C            |
| Unipolar zero error <sup>(4)</sup>                                               | 10 V range                   |                                              | -5        |                         | 5    | mV                |
|                                                                                  | 4 V and 5 V range            |                                              | -3        |                         | 3    |                   |
| Unipolar zero error drift                                                        |                              |                                              | ±2        |                         |      | ppm/°C            |
| Recovery to rated accuracy after power down                                      |                              | 1-μF Capacitor to CAP                        | 1         |                         |      | ms                |
| Power supply sensitivity (V <sub>DIG</sub> = V <sub>ANA</sub> = V <sub>D</sub> ) |                              | +4.75 V < V <sub>D</sub> < +5.25 V           | -0.5      |                         | 0.5  | LSB               |
| AC ACCURACY                                                                      |                              |                                              |           |                         |      |                   |
| SFDR                                                                             | Spurious-free dynamic range  | f <sub>i</sub> = 45 kHz                      | 86        | 95                      |      | dB <sup>(6)</sup> |
| THD                                                                              | Total harmonic distortion    | f <sub>i</sub> = 45 kHz                      |           | -95                     | -86  | dB                |
| SINAD                                                                            | Signal-to-(noise+distortion) | f <sub>i</sub> = 45 kHz                      | 72        | 73                      |      | dB                |
|                                                                                  |                              | –60-dB Input                                 |           | 32                      |      | dB                |
| SNR                                                                              | Signal-to-noise ratio        | f <sub>i</sub> = 45 kHz                      | 72        | 73                      |      | dB                |
| Full-power bandwidth <sup>(7)</sup>                                              |                              |                                              | 500       |                         |      | kHz               |
| SAMPLING DYNAMICS                                                                |                              |                                              |           |                         |      |                   |
| Aperture delay                                                                   |                              |                                              | 5         |                         |      | ns                |
| Transient response                                                               |                              | FS Step                                      | 2         |                         |      | μs                |
| Overvoltage recovery <sup>(8)</sup>                                              |                              |                                              | 150       |                         |      | ns                |
| REFERENCE                                                                        |                              |                                              |           |                         |      |                   |
| Internal reference voltage                                                       |                              | No load                                      | 2.48      | 2.5                     | 2.52 | V                 |
| Internal reference source current (must use external buffer)                     |                              |                                              | 1         |                         |      | μA                |
| Internal reference drift                                                         |                              |                                              | 8         |                         |      | ppm/°C            |
| External reference voltage range for specified linearity                         |                              |                                              | 2.3       | 2.5                     | 2.7  | V                 |
| External reference current drain                                                 |                              | Ext. 2.5-V Ref.                              | 100       |                         |      | μA                |
| DIGITAL INPUTS                                                                   |                              |                                              |           |                         |      |                   |
| Logic levels                                                                     |                              |                                              |           |                         |      |                   |
| V <sub>IL</sub>                                                                  | Low-level input voltage      |                                              | -0.3      |                         | 0.8  | V                 |
| V <sub>IH</sub>                                                                  | High-level input voltage     |                                              | 2.0       | V <sub>DIG</sub> +0.3 V |      | V                 |

(4) As measured with circuit shown in [Figure 28](#) and [Figure 29](#). Adjustable to zero with external potentiometer. Factory calibrated with 0.1%, 0.25-W resistors.

(5) For bipolar input ranges, full-scale error is the worst case of -full-scale or +full-scale uncalibrated deviation from ideal first and last code transitions, divided by the transition voltage (not divided by the full-scale range) and includes the effect of offset error. For unipolar input ranges, full-scale error is the deviation of the last code transition divided by the transition voltage. It also includes the effect of offset error.

(6) All specifications in dB are referred to a full-scale ±10-V input.

(7) Full-power bandwidth is defined as the full-scale input frequency at which signal-to-(noise + distortion) degrades to 60 dB.

(8) Recovers to specified performance after 2 x FS input overvoltage.

**ELECTRICAL CHARACTERISTICS (continued)**

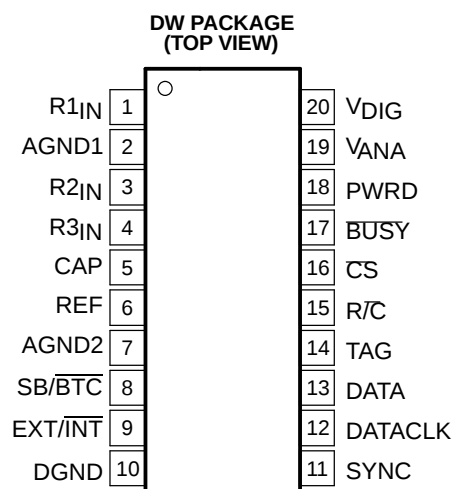
At  $T_A = -40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ ,  $f_s = 250\text{ kHz}$ ,  $V_{\text{DIG}} = V_{\text{ANA}} = 5\text{ V}$ , using internal reference and fixed resistors (See Figure 28 and Figure 29) (unless otherwise specified)

| PARAMETER                             |                                                                                  | TEST CONDITIONS                                        | ADS8508IB |     |      | UNIT |
|---------------------------------------|----------------------------------------------------------------------------------|--------------------------------------------------------|-----------|-----|------|------|
|                                       |                                                                                  |                                                        | MIN       | TYP | MAX  |      |
| I <sub>IL</sub>                       | Low-level input current                                                          | V <sub>IL</sub> = 0 V                                  |           |     | ±10  | μA   |
| I <sub>IH</sub>                       | High-level input current                                                         | V <sub>IH</sub> = 5 V                                  |           |     | ±10  | μA   |
| DIGITAL OUTPUTS                       |                                                                                  |                                                        |           |     |      |      |
|                                       | Data format (Serial 16-bits)                                                     |                                                        |           |     |      |      |
|                                       | Data coding (Binary 2's complement or straight binary)                           |                                                        |           |     |      |      |
|                                       | Pipeline delay (Conversion results only available after completed conversion.)   |                                                        |           |     |      |      |
|                                       | Data clock (Selectable for internal or external data clock)                      |                                                        |           |     |      |      |
|                                       | Internal clock (output only when transmitting data)                              | EXT/INT Low                                            |           | 9   |      | MHz  |
|                                       | External clock (can run continually but not recommended for optimum performance) | EXT/INT High                                           | 0.1       |     | 26   | MHz  |
| V <sub>OL</sub>                       | Low-level output voltage                                                         | I <sub>SINK</sub> = 1.6 mA                             |           |     | 0.4  | V    |
| V <sub>OH</sub>                       | High-level output voltage                                                        | I <sub>SOURCE</sub> = 500 μA                           | 4         |     |      | V    |
|                                       | Leakage current                                                                  | Hi-Z state, V <sub>OUT</sub> = 0 V to V <sub>DIG</sub> |           |     | ±5   | μA   |
|                                       | Output capacitance                                                               | Hi-Z state                                             |           |     | 15   | pF   |
| POWER SUPPLIES                        |                                                                                  |                                                        |           |     |      |      |
| V <sub>DIG</sub>                      | Digital input voltage                                                            | Must be ≤ V <sub>ANA</sub>                             | 4.75      | 5   | 5.25 | V    |
| V <sub>ANA</sub>                      | Analog input voltage                                                             |                                                        | 4.75      | 5   | 5.25 | V    |
| I <sub>DIG</sub>                      | Digital input current                                                            |                                                        |           | 4   |      | mA   |
| I <sub>ANA</sub>                      | Analog input current                                                             |                                                        |           | 10  |      | mA   |
| POWER DISSIPATION                     |                                                                                  |                                                        |           |     |      |      |
|                                       | PWRD Low                                                                         | f <sub>S</sub> = 250 kHz                               |           | 70  | 100  | mW   |
|                                       | PWRD High                                                                        |                                                        |           | 50  |      | μW   |
| TEMPERATURE RANGE                     |                                                                                  |                                                        |           |     |      |      |
|                                       | Specified performance                                                            |                                                        | -40       |     | 85   | °C   |
|                                       | Derated performance <sup>(9)</sup>                                               |                                                        | -55       |     | 125  | °C   |
|                                       | Storage                                                                          |                                                        | -65       |     | 150  | °C   |
| THERMAL RESISTANCE (Θ <sub>JA</sub> ) |                                                                                  |                                                        |           |     |      |      |
|                                       | SO                                                                               |                                                        |           | 75  |      | °C/W |

(9) The internal reference may not be started correctly beyond the industrial temperature range ( $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ ), therefore use of an external reference is recommended.

# **TIMING REQUIREMENTS, $T_A = -40^{\circ}\text{C}$ to $85^{\circ}\text{C}$**

| PARAMETER                          |                                                                                                       | MIN | TYP          | MAX | UNIT          |
|------------------------------------|-------------------------------------------------------------------------------------------------------|-----|--------------|-----|---------------|
| $t_{w1}$                           | Pulse duration, convert                                                                               | 40  |              |     | ns            |
| $t_{d1}$                           | Delay time, $\overline{\text{BUSY}}$ from $\text{R}/\overline{\text{C}}$ low                          |     | 6            | 20  | ns            |
| $t_{w2}$                           | Pulse duration, $\overline{\text{BUSY}}$ low                                                          |     |              | 2.2 | $\mu\text{s}$ |
| $t_{d2}$                           | Delay time, $\overline{\text{BUSY}}$ , after end of conversion                                        |     | 5            |     | ns            |
| $t_{d3}$                           | Delay time, aperture                                                                                  |     | 5            |     | ns            |
| $t_{\text{conv}}$                  | Conversion time                                                                                       |     |              | 2.2 | $\mu\text{s}$ |
| $t_{\text{acq}}$                   | Acquisition time                                                                                      | 1.8 |              |     | $\mu\text{s}$ |
| $t_{\text{conv}} + t_{\text{acq}}$ | Cycle time                                                                                            |     |              | 4   | $\mu\text{s}$ |
| $t_{d4}$                           | Delay time, $\text{R}/\overline{\text{C}}$ Low to internal DATACLK output                             |     | 270          |     | ns            |
| $t_{c1}$                           | Cycle time, internal DATACLK                                                                          |     | 110          |     | ns            |
| $t_{d5}$                           | Delay time, data valid to internal DATACLK high                                                       | 15  | 35           |     | ns            |
| $t_{d6}$                           | Delay time, data valid after internal DATACLK low                                                     | 20  | 35           |     | ns            |
| $t_{c2}$                           | Cycle time, external DATACLK                                                                          | 35  |              |     | ns            |
| $t_{w3}$                           | Pulse duration, external DATACLK high                                                                 | 15  |              |     | ns            |
| $t_{w4}$                           | Pulse duration, external DATACLK low                                                                  | 15  |              |     | ns            |
| $t_{\text{su1}}$                   | Setup time, $\text{R}/\overline{\text{C}}$ rise/fall to external DATACLK high                         | 15  | $t_{c2} + 5$ |     | ns            |
| $t_{\text{su2}}$                   | Setup time, $\text{R}/\overline{\text{C}}$ transition to $\overline{\text{CS}}$ transition            | 10  |              |     | ns            |
| $t_{d7}$                           | Delay time, SYNC, after external DATACLK high                                                         | 3   |              | 35  | ns            |
| $t_{d8}$                           | Delay time, data valid                                                                                | 2   |              | 20  | ns            |
| $t_{d9}$                           | Delay time, $\overline{\text{CS}}$ to rising edge                                                     | 10  |              |     | ns            |
| $t_{d10}$                          | Delay time, previous data available after $\overline{\text{CS}}$ , $\text{R}/\overline{\text{C}}$ low | 2   |              |     | $\mu\text{s}$ |
| $t_{\text{su3}}$                   | Setup time, $\overline{\text{BUSY}}$ transition to first external DATACLK                             | 5   |              |     | ns            |
| $t_{d11}$                          | Delay time, final external DATACLK to $\overline{\text{BUSY}}$ falling edge                           |     |              | 1   | $\mu\text{s}$ |
| $t_{\text{su3}}$                   | Setup time, TAG valid                                                                                 | 0   |              |     | ns            |
| $t_{h1}$                           | Hold time, TAG valid                                                                                  | 2   |              |     | ns            |



## Terminal Functions

| TERMINAL              |     | I/O | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
|-----------------------|-----|-----|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                  | NO. |     |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| AGND1                 | 2   | –   | Analog ground. Used internally as ground reference point. Minimal current flow.                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| AGND2                 | 7   | –   | Analog ground                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| BUSY                  | 17  | O   | Busy output. Falls when a conversion is started, and remains low until the conversion is completed and the data is latched into the output shift register.                                                                                                                                                                                                                                                                                                                                                                                              |
| CAP                   | 5   | –   | Reference buffer capacitor. 2.2-μF Tantalum to ground.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| $\overline{CS}$       | 16  | –   | Chip select. Internally ORed with $R/\overline{C}$                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| DATA                  | 13  | O   | Serial data output. Data is synchronized to DATACLK, with the format determined by the level of SB/ $\overline{BTC}$ . In the external clock mode, after 16 bits of data, the ADS8508 outputs the level input on TAG as long as $\overline{CS}$ is low and $R/\overline{C}$ is high (see Figure 8 and Figure 9). If EXT/ $\overline{INT}$ is low, data is valid on both the rising and falling edges of DATACLK, and between conversions DATA stays at the level of the TAG input when the conversion was started.                                      |
| DATACLK               | 12  | I/O | Either an input or an output depending on the EXT/ $\overline{INT}$ level. Output data is synchronized to this clock. If EXT/ $\overline{INT}$ is low, DATACLK transmits 16 pulses after each conversion, and then remains low between conversions.                                                                                                                                                                                                                                                                                                     |
| DGND                  | 10  | –   | Digital ground                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| EXT/ $\overline{INT}$ | 9   | –   | Selects external or internal clock for transmitting data. If high, data is output synchronized to the clock input on DATACLK. If low, a convert command initiates the transmission of the data from the previous conversion, along with 16-clock pulses output on DATACLK.                                                                                                                                                                                                                                                                              |
| NC                    | –   | –   | No connect                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| PWRD                  | 18  | I   | Power down input. If high, conversions are inhibited and power consumption is significantly reduced. Results from the previous conversion are maintained in the output shift register.                                                                                                                                                                                                                                                                                                                                                                  |
| $R/\overline{C}$      | 15  | I   | Read/convert input. With $\overline{CS}$ low, a falling edge on $R/\overline{C}$ puts the internal sample-and-hold into the hold state and starts a conversion. When EXT/ $\overline{INT}$ is low, this also initiates the transmission of the data results from the previous conversion. If EXT/ $\overline{INT}$ is high, a rising edge on $R/\overline{C}$ with $\overline{CS}$ low, or a falling edge on $\overline{CS}$ with $R/\overline{C}$ high, transmits a pulse on SYNC and initiates the transmission of data from the previous conversion. |
| REF                   | 6   | I/O | Reference input/output. Outputs internal 2.5-V reference. Can also be driven by external system reference. In both cases, bypass to ground with a 2.2-μF tantalum capacitor.                                                                                                                                                                                                                                                                                                                                                                            |
| R1 <sub>IN</sub>      | 1   | I   | Analog input. See Table 3 for input range connections.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| R2 <sub>IN</sub>      | 3   | I   | Analog input. See Table 3 for input range connections.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| R3 <sub>IN</sub>      | 4   | I   | Analog input. See Table 3 for input range connections.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| SB/ $\overline{BTC}$  | 8   | O   | Select straight binary or binary 2's complement data output format. If high, data is output in a straight binary format. If low, data is output in a binary 2's complement format.                                                                                                                                                                                                                                                                                                                                                                      |
| SYNC                  | 11  | O   | Sync output. This pin is used to supply a data synchronization pulse when the EXT level is high and at least one external clock pulse has occurred when not in the read mode. See the external clock modes descriptions.                                                                                                                                                                                                                                                                                                                                |
| TAG                   | 14  | I   | Tag input for use in the external clock mode. If EXT is high, digital data input from TAG is output on DATA with a delay that is dependent on the external clock mode. See Figure 8 and Figure 9.                                                                                                                                                                                                                                                                                                                                                       |
| V <sub>ANA</sub>      | 19  | I   | Analog supply input. Nominally +5 V. Connect directly to pin 20, and decouple to ground with 0.1-μF ceramic and 10-μF tantalum capacitors.                                                                                                                                                                                                                                                                                                                                                                                                              |
| V <sub>DIG</sub>      | 20  | I   | Digital supply input. Nominally +5 V. Connect directly to pin 19. Must be ≤ V <sub>ANA</sub> .                                                                                                                                                                                                                                                                                                                                                                                                                                                          |

## PARAMETER MEASUREMENT INFORMATION

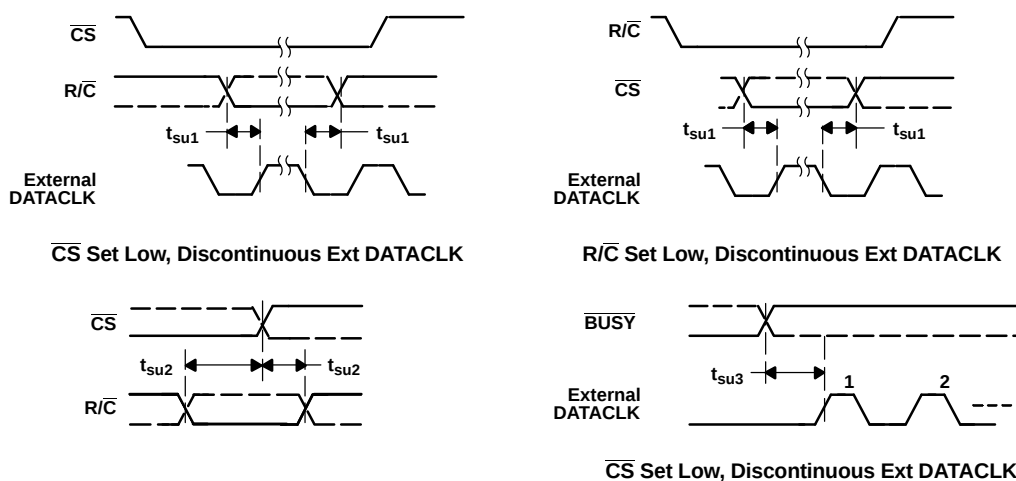


Figure 1. Critical Timing

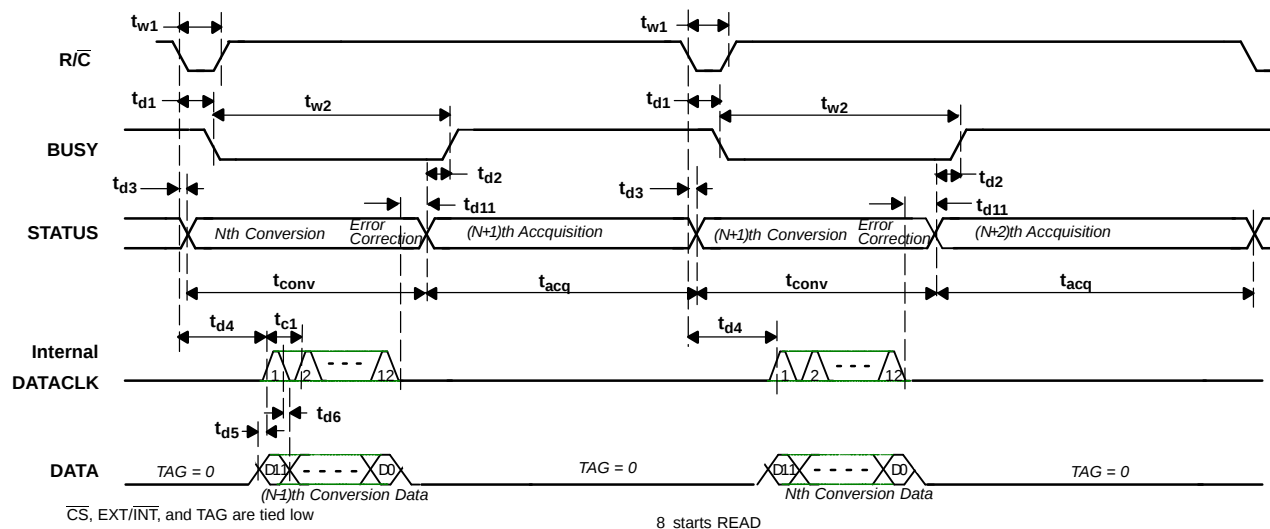


Figure 2. Basic Conversion Timing - Internal DATACLK (Read Previous Data During Conversion)

## PARAMETER MEASUREMENT INFORMATION (continued)

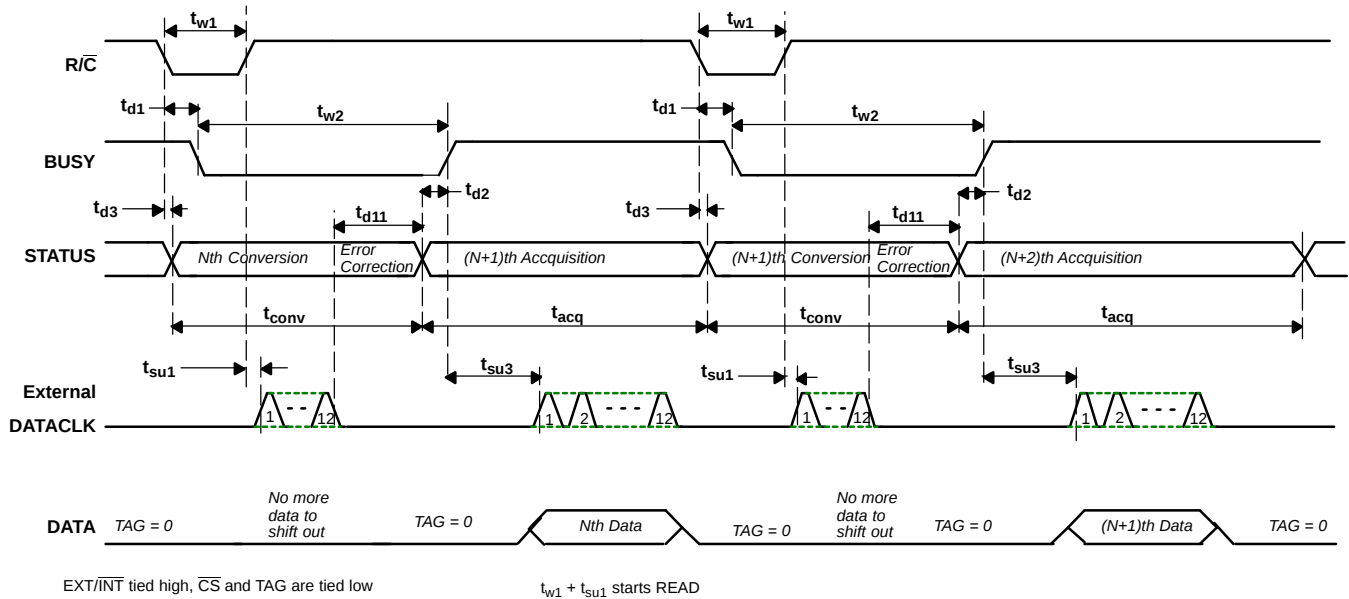


Figure 3. Basic Conversion Timing - External DATACLK

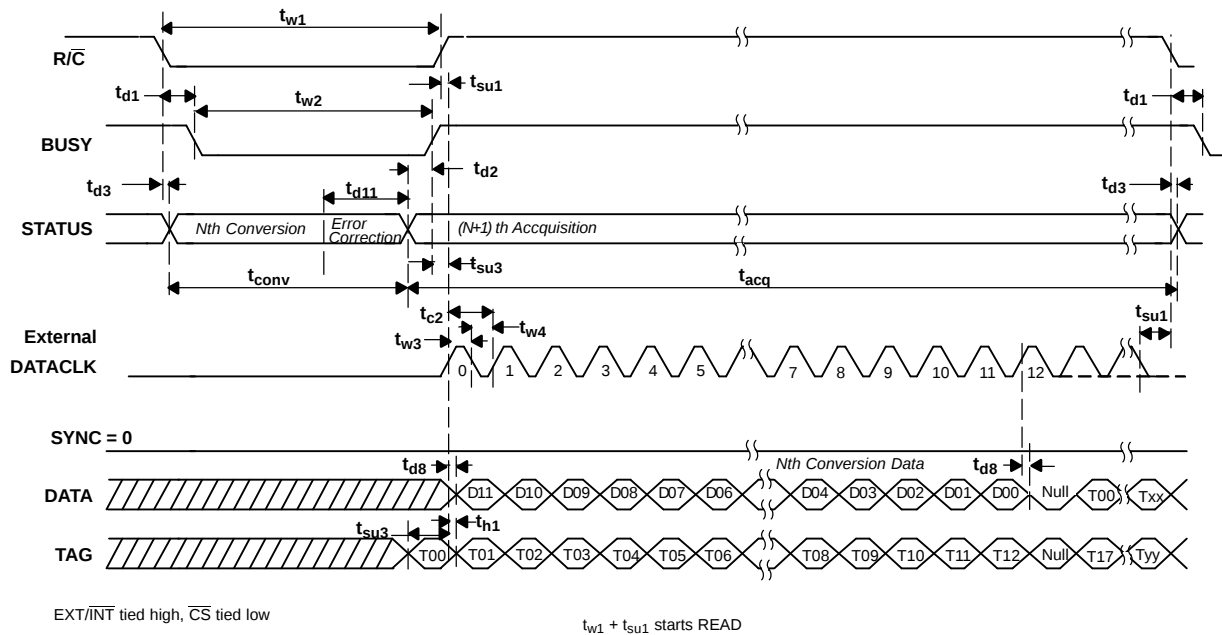


Figure 4. Read After Conversion (Discontinuous External DATACLK)

## PARAMETER MEASUREMENT INFORMATION (continued)

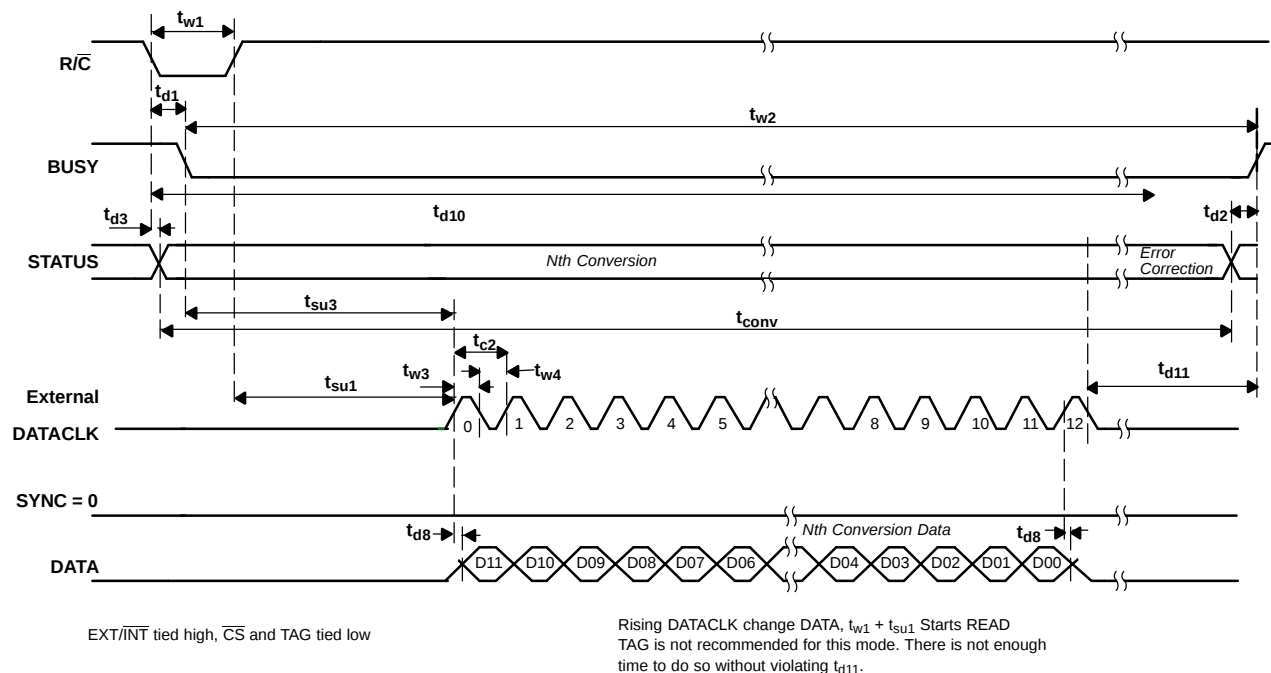


Figure 5. Read During Conversion (Discontinuous External DATACLK)

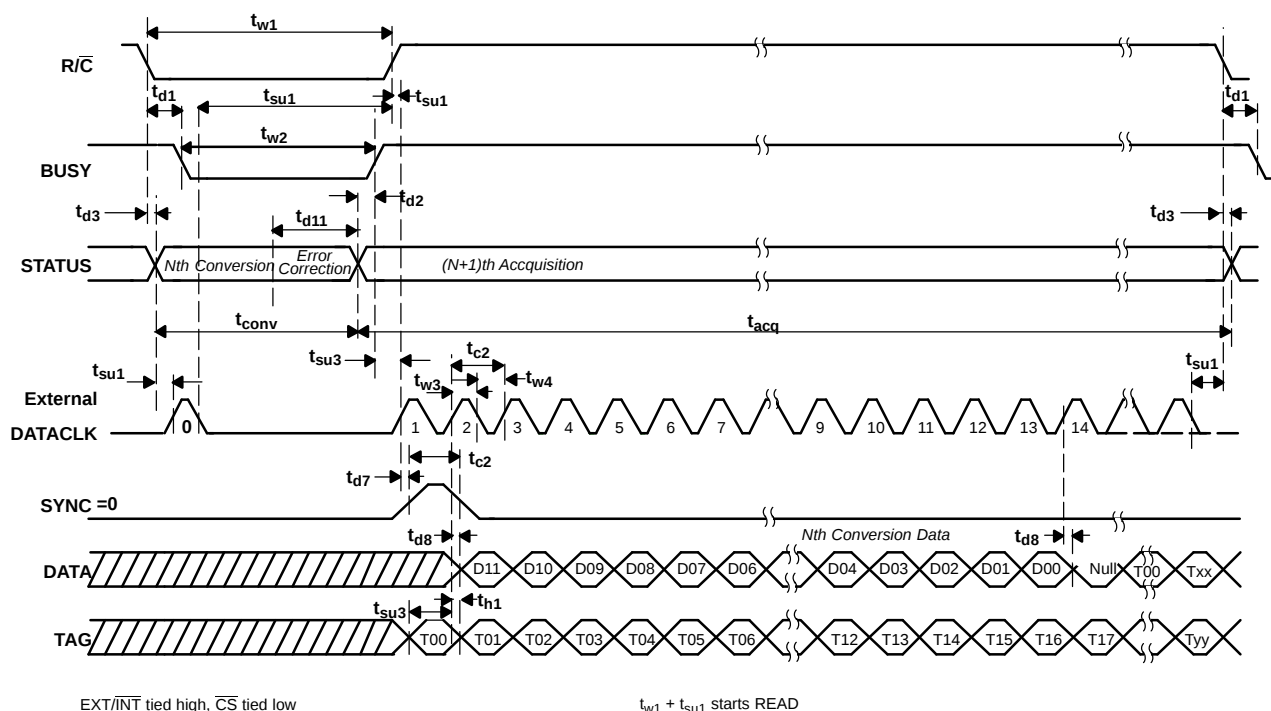


Figure 6. Read After Conversion With SYNC (Discontinuous External DATACLK)

## PARAMETER MEASUREMENT INFORMATION (continued)

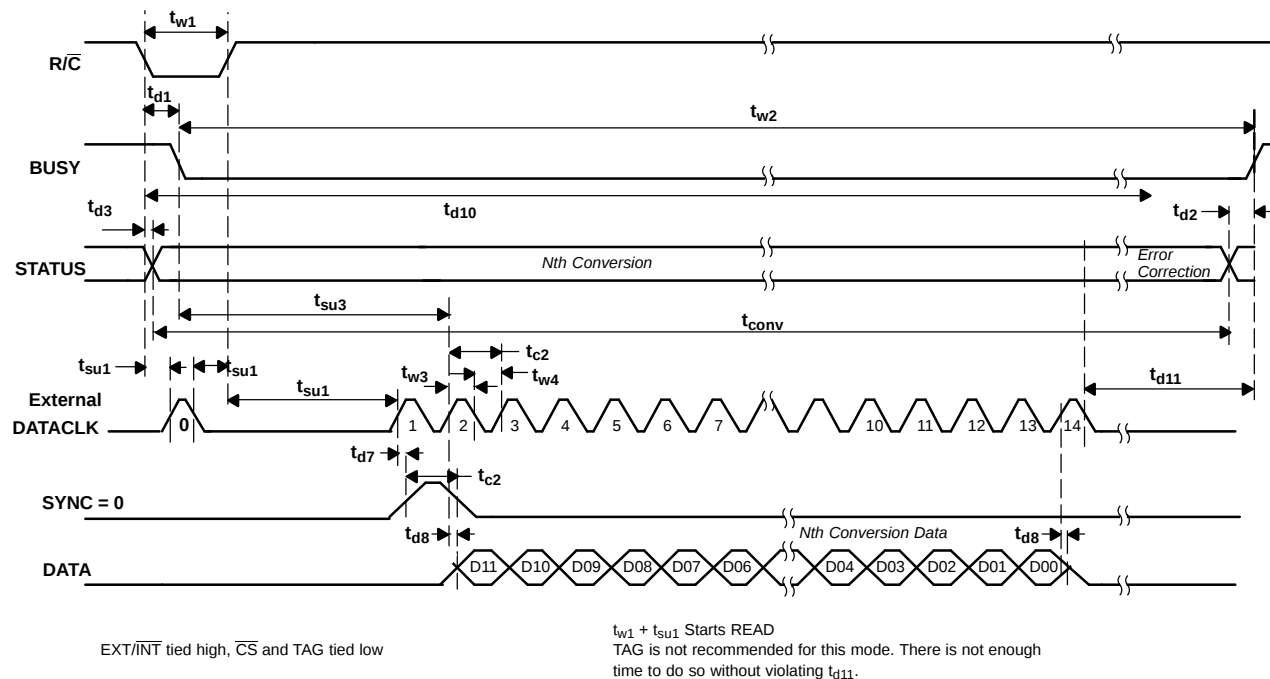


Figure 7. Read During Conversion With SYNC (Discontinuous External DATACLK)

# PARAMETER MEASUREMENT INFORMATION (continued)

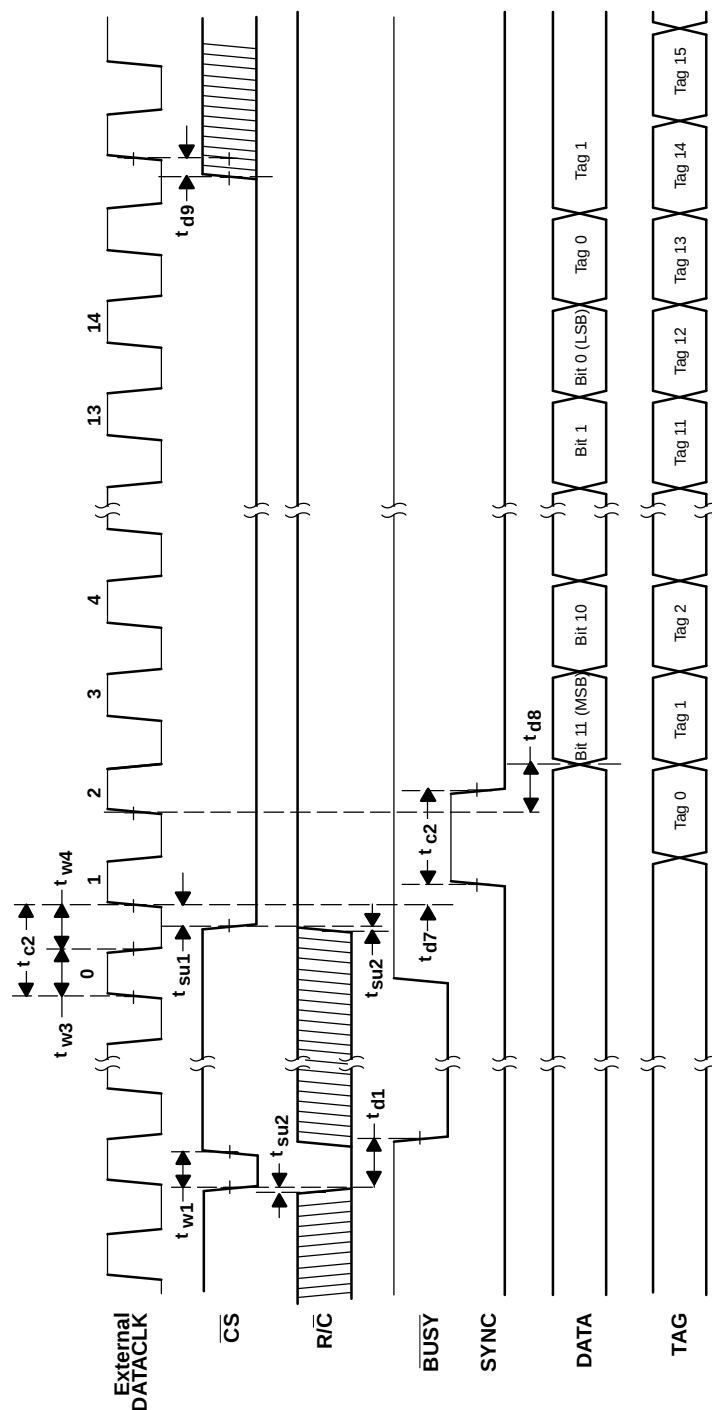
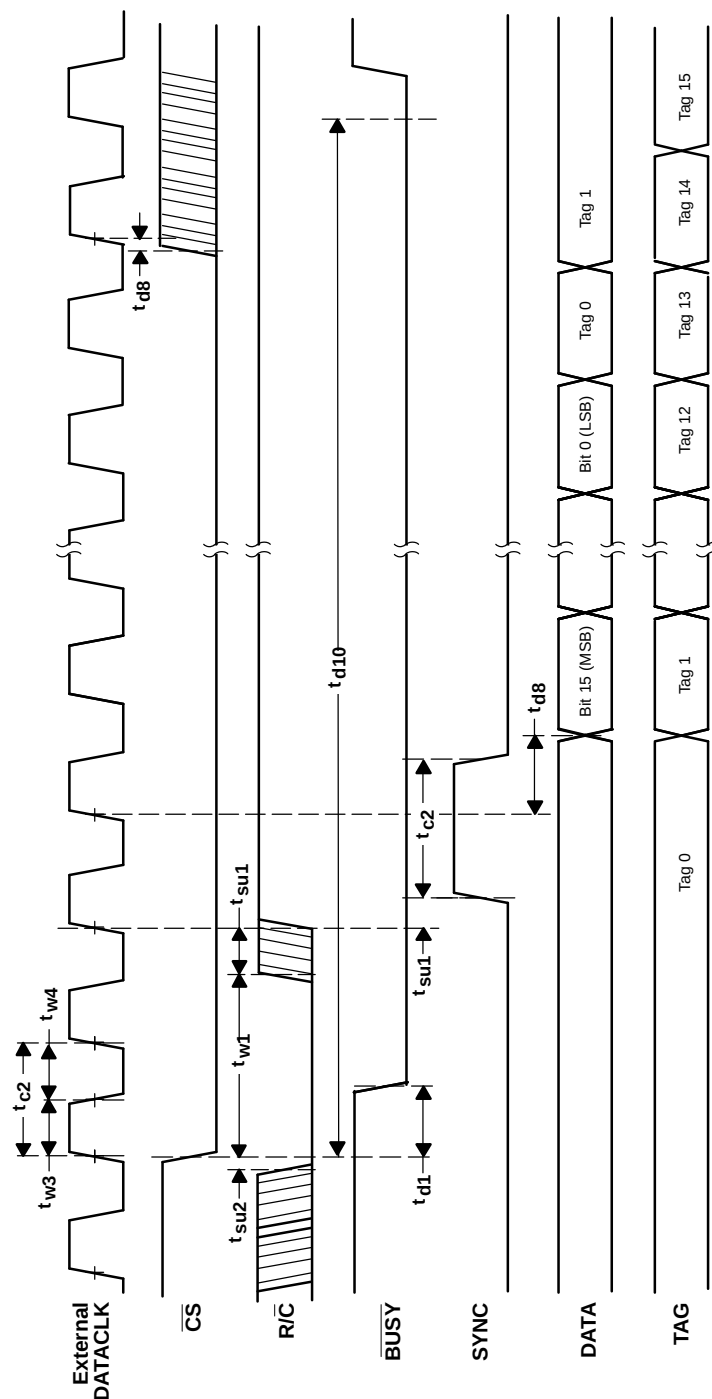


Figure 8. Conversion and Read Timing with Continuous External DATACLK (EXT/INT Tied High) Read After Conversions (Not Recommended)

### PARAMETER MEASUREMENT INFORMATION (continued)



**Figure 9. Conversion and Read Timing with Continuous External DATACLK (EXT/INT Tied High) Read Previous Conversion Result During Conversion (Not Recommended)**

## TYPICAL CHARACTERISTICS

**SPURIOUS FREE DYNAMIC RANGE  
vs  
FREE-AIR TEMPERATURE**

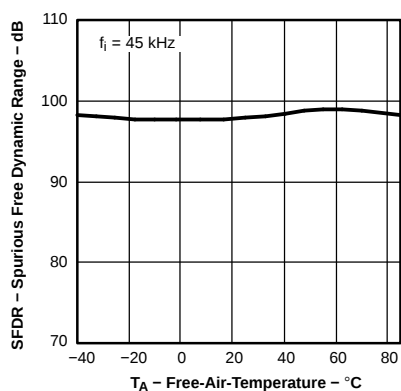


Figure 10.

**TOTAL HARMONIC DISTORTION  
vs  
FREE-AIR TEMPERATURE**

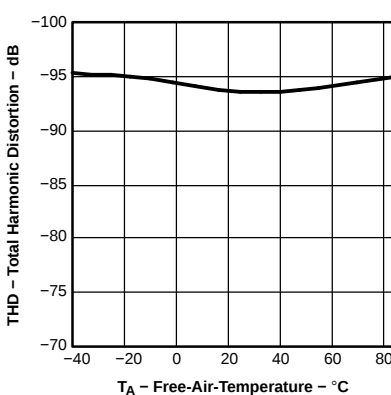


Figure 11.

**SIGNAL-TO-NOISE RATIO  
vs  
FREE-AIR TEMPERATURE**

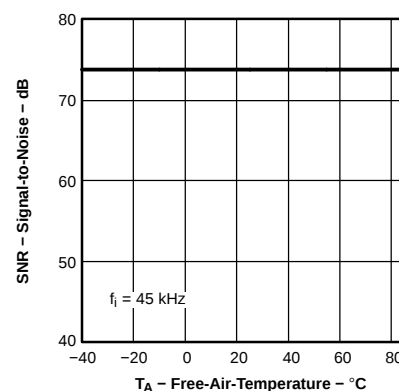


Figure 12.

**SIGNAL-TO-NOISE AND DISTOR-  
TION  
vs  
FREE-AIR TEMPERATURE**

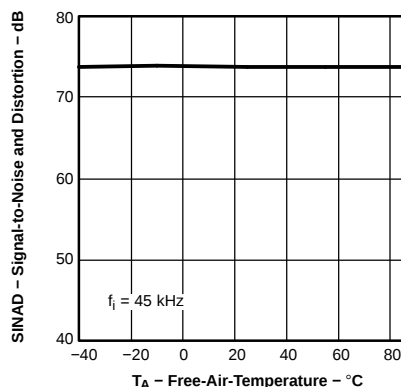


Figure 13.

**SIGNAL-TO-NOISE RATIO  
vs  
INPUT FREQUENCY**

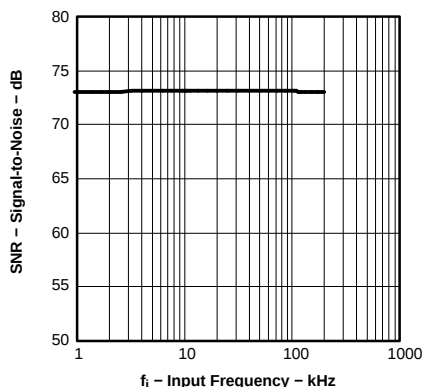


Figure 14.

**SIGNAL-TO-NOISE AND DISTOR-  
TION  
vs  
INPUT FREQUENCY**

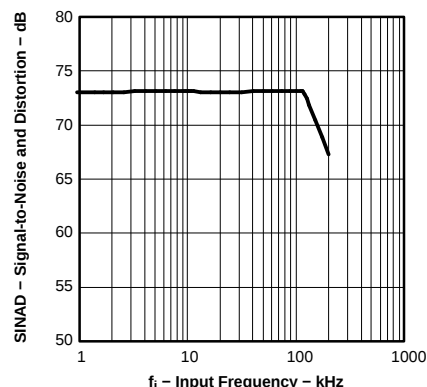


Figure 15.

**SPURIOUS FREE DYNAMIC RANGE  
vs  
INPUT FREQUENCY**

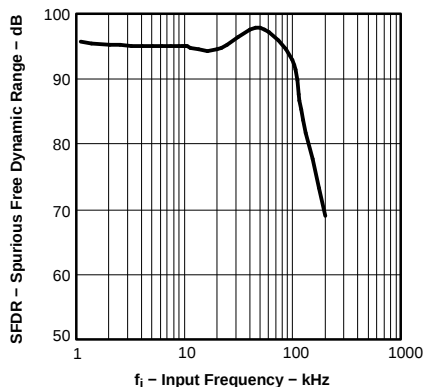


Figure 16.

**TOTAL HARMONIC DISTORTION  
vs  
INPUT FREQUENCY**

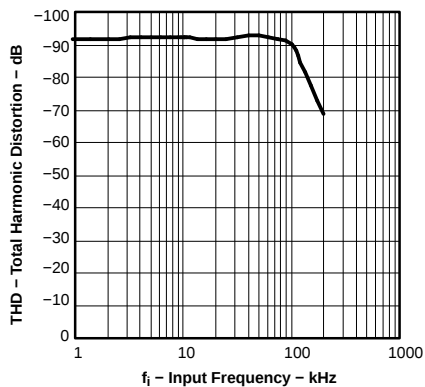


Figure 17.

**BIPOLAR ZERO SCALE ERROR  
vs  
FREE-AIR TEMPERATURE**

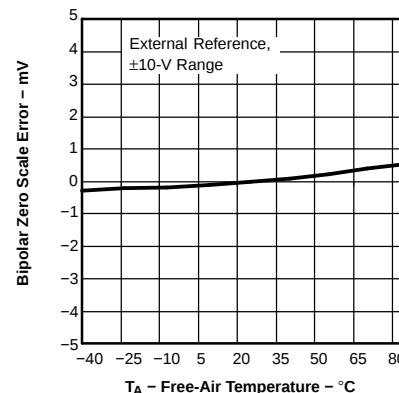


Figure 18.

## TYPICAL CHARACTERISTICS (continued)

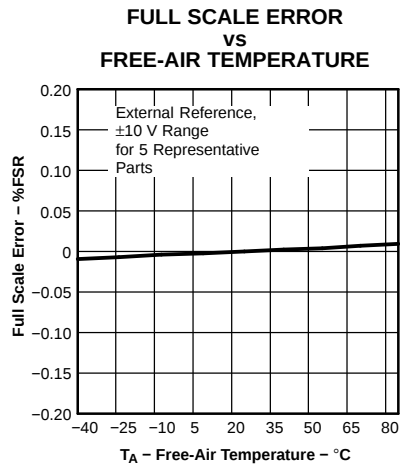


Figure 19.

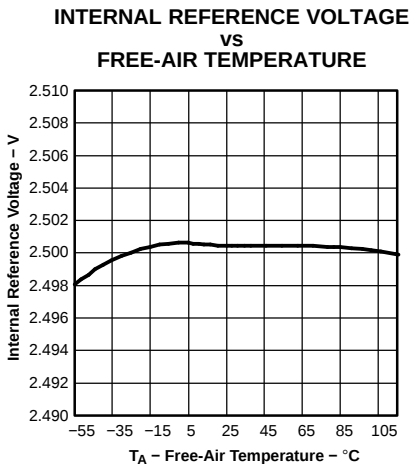


Figure 20.

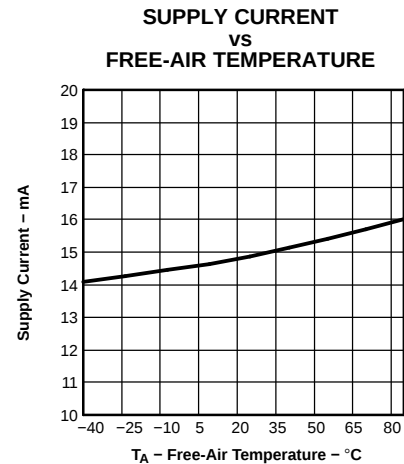


Figure 21.

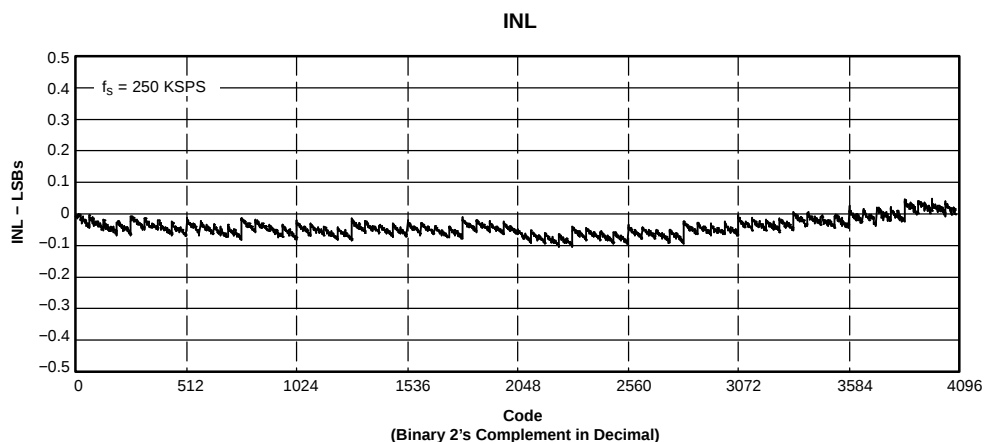


Figure 22.

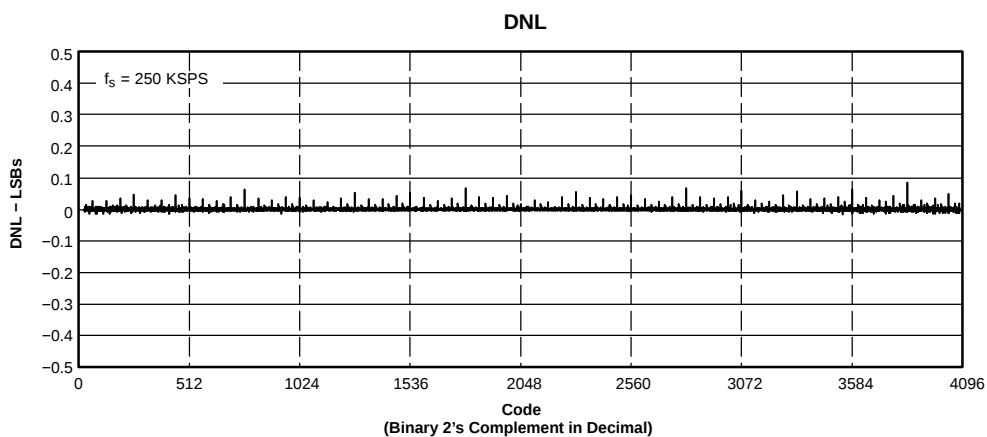


Figure 23.

## TYPICAL CHARACTERISTICS (continued)

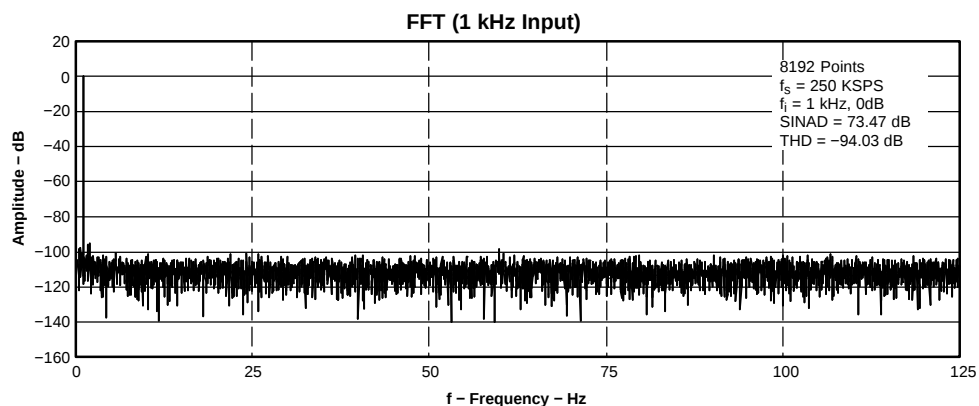


Figure 24.

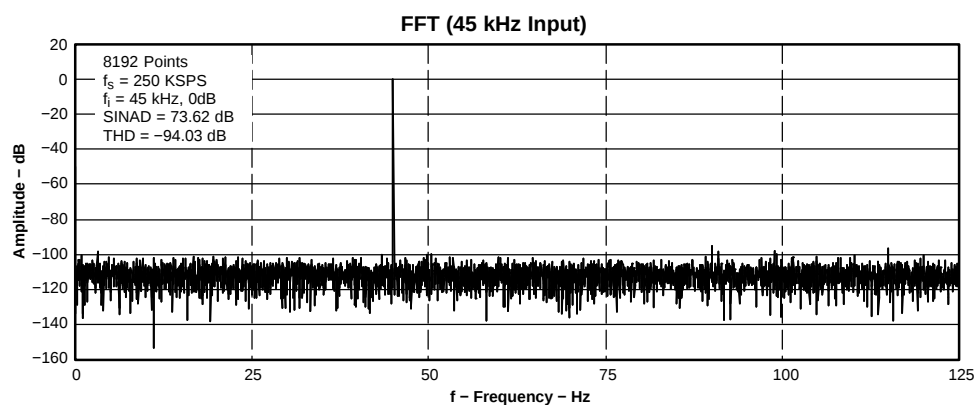


Figure 25.

## BASIC OPERATION

Two signals control conversion in the ADS8508:  $\overline{CS}$  and  $R/\overline{C}$ . These two signals are internally ORed together. To start a conversion the chip must be selected,  $\overline{CS}$  low, and the conversion signal must be active,  $R/\overline{C}$  low. Either signal can be brought low first. Conversion starts on the falling edge of the second signal.  $\overline{BUSY}$  goes low when conversion starts and returns high after the data from that conversion is shifted into the internal storage register. Sampling begins when  $\overline{BUSY}$  goes high.

To reduce the number of control pins  $\overline{CS}$  can be tied low permanently. The  $R/\overline{C}$  pin now controls conversion and data reading exclusively. In the external clock mode this means that the ADS8508 will clock out data whenever  $R/\overline{C}$  is brought high and the external clock is active. In the internal clock mode data is clocked out every convert cycle regardless of the states of  $\overline{CS}$  and  $R/\overline{C}$ . The ADS8508 provides a TAG input for cascading multiple converters together.

## READING DATA

The conversion result is available as soon as  $\overline{BUSY}$  returns to high therefore, data always represents the conversion previously completed even when it is read during a conversion. The ADS8508 outputs serial data in either straight binary or binary two's complement format. The  $SB/\overline{BTC}$  pin controls the format. Data is shifted out MSB first. The first conversion immediately following a power-up will not produce a valid conversion result.

Data can be clocked out with either the internally generated clock or with an external clock. The  $EXT/\overline{INT}$  pin controls this function. If external clock is used the TAG input can be used to daisy-chain multiple ADS8508 data pins together.

## INTERNAL DATACLK

In the internal clock mode data for the previous conversion is clocked out during each conversion period. The internal data clock is synchronized to the internal conversion clock so that it does not interfere with the conversion process.

The DATACLK pin becomes an output when  $EXT/\overline{INT}$  is low. 12 clock pulses are generated at the beginning of each conversion after timing  $t_b$  is satisfied, i.e. you can only read previous conversion result during conversion. DATACLK returns to low when it is inactive. The 12 bits of serial data are shifted out the DATA pin synchronous to this clock with each bit available on a rising and then a falling edge. DATA pin returns to the state of TAG pin input sensed at the start of transmission.

## EXTERNAL DATACLK

The external clock mode offers several ways to retrieve conversion results. However, since the external clock cannot be synchronized to the internal conversion clock care must be taken to avoid corrupting the data.

When  $EXT/\overline{INT}$  is set high, the  $R/\overline{C}$  and  $\overline{CS}$  signals control the read state. When the read state is initiated the result from the previously completed conversion is shifted out the DATA pin synchronous to the external clock that is connected to the DATACLK pin. Each bit is available on a falling and then a rising edge. The maximum external clock speed of 28.5 MHz allows data shifted out quickly either at the beginning of conversion or the beginning of sampling.

There are several modes of operation available when using an external clock. It is recommended that the external clock run only while reading data. This is the discontinuous clock mode. Since the external clock is not synchronized to the internal clock that controls conversion slight changes in the external clock can cause conflicts that can corrupt the conversion process. Specifications with a continuously running external clock cannot be guaranteed. It is especially important that the external clock does not run during the second half of the conversion cycle (approximately the time period specified by  $t_{d11}$ , see timing table).

In the discontinuous clock mode data can be read during conversion or during sampling, with or without a SYNC pulse. Data read during a conversion must meet the  $t_{d11}$  timing specification. Data read during sampling must be complete before starting a conversion.

Whether reading during sampling or during conversion a SYNC pulse is generated whenever at least one rising edge of the external clock occurs while the part is not in the read state. In the *discontinuous external clock with SYNC* mode a SYNC pulse follows the first rising edge after the read command. The data is shifted out after the SYNC pulse. The first rising clock edge after the read command generates a SYNC pulse. The SYNC pulse can be detected on the next falling edge and then the next rising edge. Successively, each bit can be read first on the falling edge and then on the next rising edge. Thus 13 clock pulses after the read command are required to read on the falling edge, and 14 clock pulses are necessary to read on the rising edge.

**Table 2. DATACLK Pulses**

| DESCRIPTION                     | DATACLK PULSES REQUIRED |              |
|---------------------------------|-------------------------|--------------|
|                                 | WITH SYNC               | WITHOUT SYNC |
| Read on falling edge of DATACLK | 13                      | 12           |
| Read on rising edge of DATACLK  | 14                      | 13           |

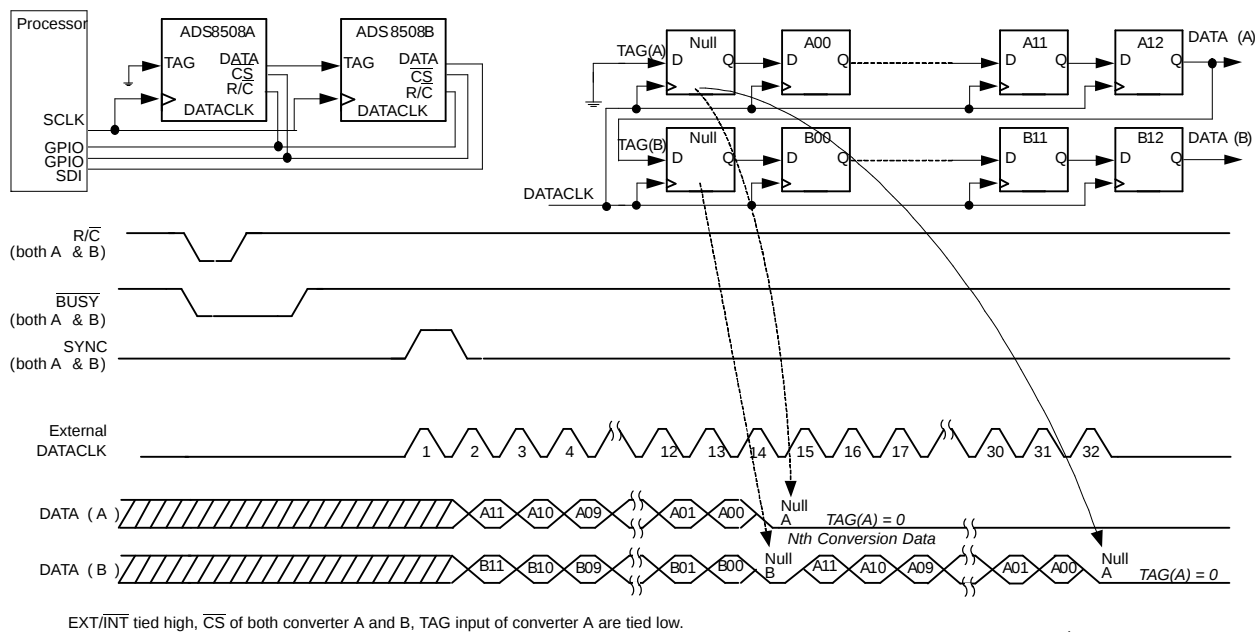
If the clock is entirely inactive when not in the read state no SYNC pulse is generated. In this case the first rising clock edge shifts out the MSB. The MSB can be read on the first falling edge or on the next rising edge. In this *discontinuous external clock mode with no SYNC*, 12 clocks are necessary to read the data on the falling edge and 13 clocks for reading on the rising edge. Data always represents the conversion already completed.

## TAG FEATURE

The TAG feature allows the data from multiple ADS8508 converters to be read on a single serial line. The converters are cascaded together using the DATA pins as outputs and the TAG pins as inputs as illustrated in [Figure 26](#). The DATA pin of the last converter drives the processor's serial data input. Data is then shifted through each converter, synchronous to the externally supplied data clock, onto the serial data line. The internal clock cannot be used for this configuration.

The preferred timing uses the discontinuous, external, data clock during the sampling period. Data must be read during the sampling period because there is not sufficient time to read data from multiple converters during a conversion period without violating the  $t_{d11}$  constraint (see the EXTERNAL DATACLOCK section). The sampling period must be sufficiently long to allow all data words to be read before starting a new conversion.

Note, in [Figure 26](#), that a NULL bit separates the data word from each converter. The state of the DATA pin at the end of a READ cycle reflects the state of the TAG pin at the start of the cycle. This is true in all READ modes, including the internal clock mode. For example, when a single converter is used in the internal clock mode the state of the TAG pin determines the state of the DATA pin after all 12 bits have shifted out. When multiple converters are cascaded together this state forms the NULL bit that separates the words. Thus, with the TAG pin of the first converter grounded as shown in [Figure 26](#) the NULL bit becomes a zero between each data word.



**Figure 26. Timing of TAG Feature With Single Conversion (Using External DATACLK)**

## ANALOG INPUTS

The ADS8508 has six analog input ranges as shown in [Table 3](#). The offset and gain specifications are factory calibrated with 0.1%, ¼-W, external resistors as shown in [Figure 28](#) and [Figure 29](#). The external resistors can be omitted if larger gain and offset errors are acceptable or if using software calibration. The hardware trim circuitry shown in [Figure 28](#) and [Figure 29](#) can reduce the errors to zero.

The analog input pins  $R1_{IN}$ ,  $R2_{IN}$ , and  $R3_{IN}$  have  $\pm 25$ -V overvoltage protection. The input signal must be referenced to AGND1. This will minimize the ground loop problem typical to analog designs. The analog input should be driven by a low impedance source. A typical driving circuit using OPA627 or OPA132 is shown in [Figure 27](#).

The ADS8508 can operate with its internal 2.5-V reference or an external reference. An external reference connected to pin 6 (REF) bypasses the internal reference. The external reference must drive the 4-k $\Omega$  resistor that separates pin 6 from the internal reference (see the illustration on page 1). The load will vary with the difference between the internal and external reference voltages. The external reference voltage can vary from 2.3 V to 2.7 V. The internal reference will be approximately 2.5 V. The reference, whether internal or external, is buffered internally with a buffer with its output on pin 5 (CAP).

The ADS8508 is factory tested with 2.2- $\mu$ F capacitors connected to pins 5 and 6 (CAP and REF). Each capacitor should be placed as close as possible to its pin. The capacitor on pin 6 band limits the internal reference noise. A smaller capacitor can be used but it may degrade SNR and SINAD. The capacitor on pin 5 stabilizes the reference buffer and provides switching charge to the CDAC during conversion. Capacitors smaller than 1  $\mu$ F can cause the buffer to become unstable may not hold sufficient charge for the CDAC. The parts are tested to specifications with 2.2  $\mu$ F so larger capacitors are not necessary. The ESR (equivalent series resistance) of these compensation capacitors is also critical. Keep the total ESR under 3  $\Omega$ . See the TYPICAL CHARACTERISTICS section for how the performance is affected by ESR.

Neither the internal reference nor the buffer should be used to drive an external load. Such loading can degrade performance. Any load on the internal reference causes a voltage drop across the 4-k $\Omega$  resistor and will affect gain. The internal buffer is capable of driving  $\pm 2$ -mA loads but any load can cause perturbations of the reference at the CDAC, degrading performance. It should be pointed out that, unlike other competitor's parts with similar input structure, the ADS8508 does not require a second high speed amplifier used as buffer to isolate the CAP pin from the signal dependent current in the  $R3_{IN}$  pin but can tolerate it if one do exist.

The external reference voltage can vary from 2.3 V to 2.7 V. The reference voltage determines the size of the least significant bit (LSB). The larger reference voltages produce a larger LSB, which can improve SNR. Smaller reference voltages can degrade SNR.

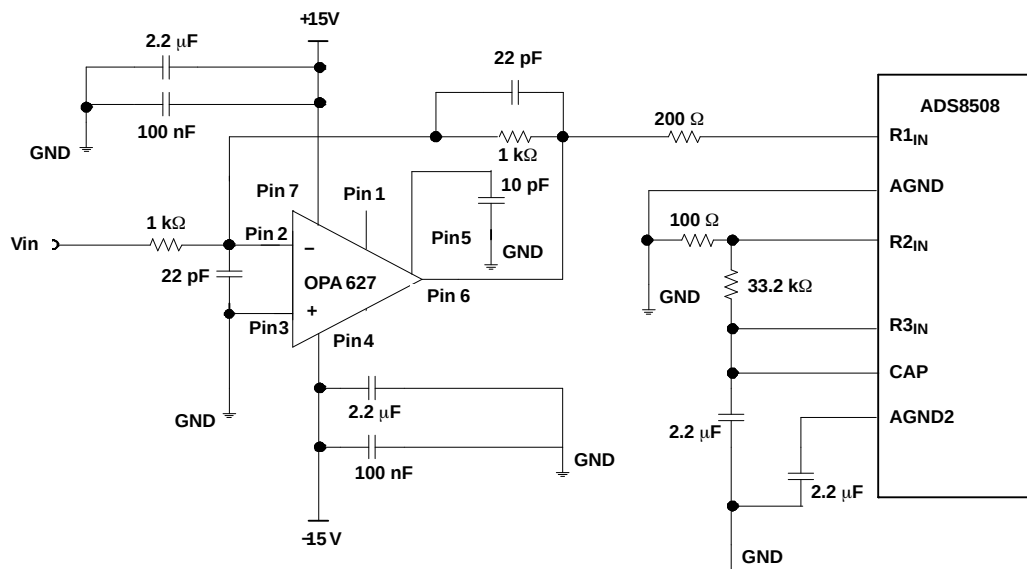


Figure 27. Typical Driving Circuitry (±10 V, No Trim)

Table 3. Input Range Connections (see Figure 28 and Figure 29 for complete information)

| ANALOG INPUT RANGE | CONNECT R1 <sub>IN</sub> VIA 200 Ω TO | CONNECT R2 <sub>IN</sub> VIA 100 Ω TO | CONNECT R3 TO   | IMPEDANCE |
|--------------------|---------------------------------------|---------------------------------------|-----------------|-----------|
| ±10 V              | V <sub>IN</sub>                       | AGND                                  | CAP             | 11.5 kΩ   |
| ±5 V               | AGND                                  | V <sub>IN</sub>                       | CAP             | 6.7 kΩ    |
| ±3.33 V            | V <sub>IN</sub>                       | V <sub>IN</sub>                       | CAP             | 5.4 kΩ    |
| 0 V to 10 V        | AGND                                  | V <sub>IN</sub>                       | AGND            | 6.7 kΩ    |
| 0 V to 5 V         | AGND                                  | AGND                                  | V <sub>IN</sub> | 5.0 kΩ    |
| 0 V to 4 V         | V <sub>IN</sub>                       | AGND                                  | V <sub>IN</sub> | 5.4 kΩ    |

Table 4. Control Truth Table

| SPECIFIC FUNCTION                                        | CS    | R/C   | BUSY  | EXT/INT | DATACLK | PWRD | SB/BTC | OPERATION                                                                                                                                                          |
|----------------------------------------------------------|-------|-------|-------|---------|---------|------|--------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Initiate conversion and output data using internal clock | 1 > 0 | 0     | 1     | 0       | Output  | 0    | x      | Initiates conversion <i>n</i> . Data from conversion <i>n</i> - 1 clocked out on DATA synchronized to 16 clock pulses output on DATACLK.                           |
|                                                          | 0     | 1 > 0 | 1     | 0       | Output  | 0    | x      |                                                                                                                                                                    |
| Initiate conversion and output data using external clock | 1 > 0 | 0     | 1     | 1       | Input   | 0    | x      | Initiates conversion <i>n</i> .                                                                                                                                    |
|                                                          | 0     | 1 > 0 | 1     | 1       | Input   | 0    | x      | Initiates conversion <i>n</i> .                                                                                                                                    |
|                                                          | 1 > 0 | 1     | 1     | 1       | Input   | x    | x      | Outputs a pulse on SYNC followed by data from conversion <i>n</i> clocked out synchronized to external DATACLK.                                                    |
|                                                          | 1 > 0 | 1     | 0     | 1       | Input   | 0    | x      | Outputs a pulse on SYNC followed by data from conversion <i>n</i> - 1 clocked out synchronized to external DATACLK. <sup>(1)</sup> Conversion <i>n</i> in process. |
|                                                          | 0     | 0 > 1 | 0     | 1       | Input   | 0    | x      |                                                                                                                                                                    |
| Incorrect conversions                                    | 0     | 0     | 0 > 1 | x       | x       | 0    | x      | CS or R/C must be HIGH or a new conversion will be initiated without time for acquisition.                                                                         |
| Power down                                               | x     | x     | x     | x       | x       | 0    | x      | Analog circuitry powered. Conversion can proceed..                                                                                                                 |
|                                                          | x     | x     | x     | x       | x       | 1    | x      | Analog circuitry disabled. Data from previous conversion maintained in output registers.                                                                           |

(1) See Figure XXX for the constraints on previous data valid during a conversion.

**Table 4. Control Truth Table (continued)**

|                         |   |   |   |   |   |   |   |                                                       |
|-------------------------|---|---|---|---|---|---|---|-------------------------------------------------------|
| Selecting output format | x | x | x | x | x | x | 0 | Serial data is output in binary 2s complement format. |
|                         | x | x | x | x | x | x | 1 | Serial data is output in straight binary format.      |

**Table 5. Output Codes and Ideal Input Voltages**

| DESCRIP-<br>TION            | ANALOG INPUT |            |             |            |             |            | DIGITAL OUTPUT                            |          |                                     |          |
|-----------------------------|--------------|------------|-------------|------------|-------------|------------|-------------------------------------------|----------|-------------------------------------|----------|
|                             |              |            |             |            |             |            | BINARY 2's<br>COMPLEMENTS<br>(SB/BTC LOW) |          | STRAIGHT<br>BINARY<br>(SB/BTC HIGH) |          |
|                             |              |            |             |            |             |            | BINARY CODE                               | HEX CODE | BINARY CODE                         | HEX CODE |
| Full-scale range            | ±10          | ±5         | ±3.33 V     | 0 V to 5 V | 0 V to 10 V | 0 V to 4 V |                                           |          |                                     |          |
| Least significant bit (LSB) | 4.88 mV      | 2.44 mV    | 1.63 mV     | 1.22 mV    | 2.44 mV     | 0.98 mV    |                                           |          |                                     |          |
| Full scale (FS - 1LSB)      | 9.99512 V    | 4.997567 V | 3.33171 V   | 4.99878 V  | 9.99756 V   | 3.99902 V  | 0111 1111 1111                            | 7FF      | 1111 1111 1111                      | FFF      |
| Midscale                    | 0 V          | 0 V        | 0 V         | 2.5 V      | 5 V         | 2 V        | 0000 0000 0000                            | 000      | 1000 0000 0000                      | 800      |
| One LSB below midscale      | -4.88 mV     | -2.44 mV   | -1.63 mV    | 2.49878 V  | 4.99756 V   | 1.99902 V  | 1111 1111 1111                            | FFF      | 0111 1111 1111                      | 7FF      |
| -Full scale                 | -10 V        | -5 V       | -3.333333 V | 0 V        | 0 V         | 0 V        | 1000 0000 0000                            | 800      | 0000 0000 0000                      | 000      |

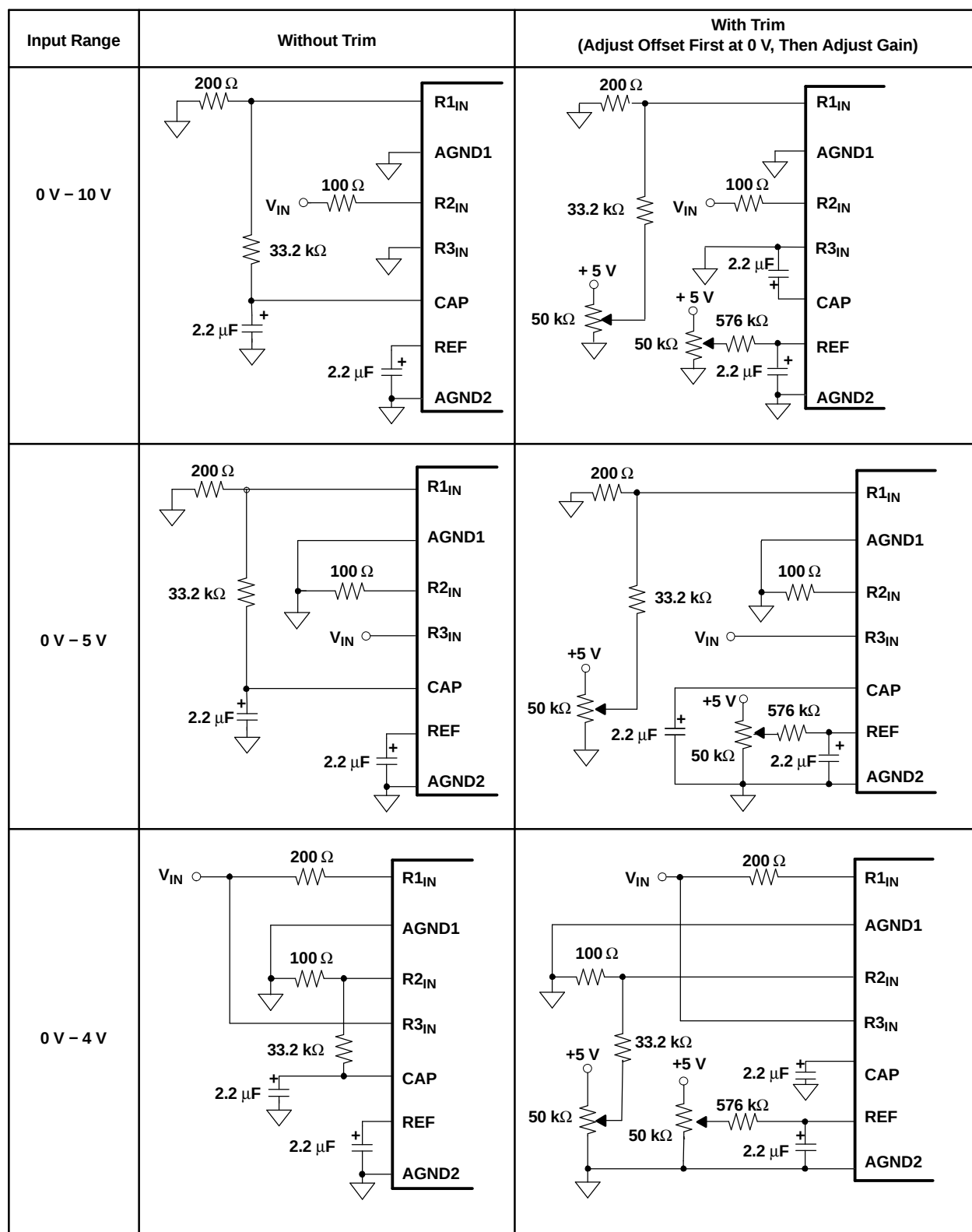


Figure 28. Offset/Gain Circuits for Unipolar Input Ranges

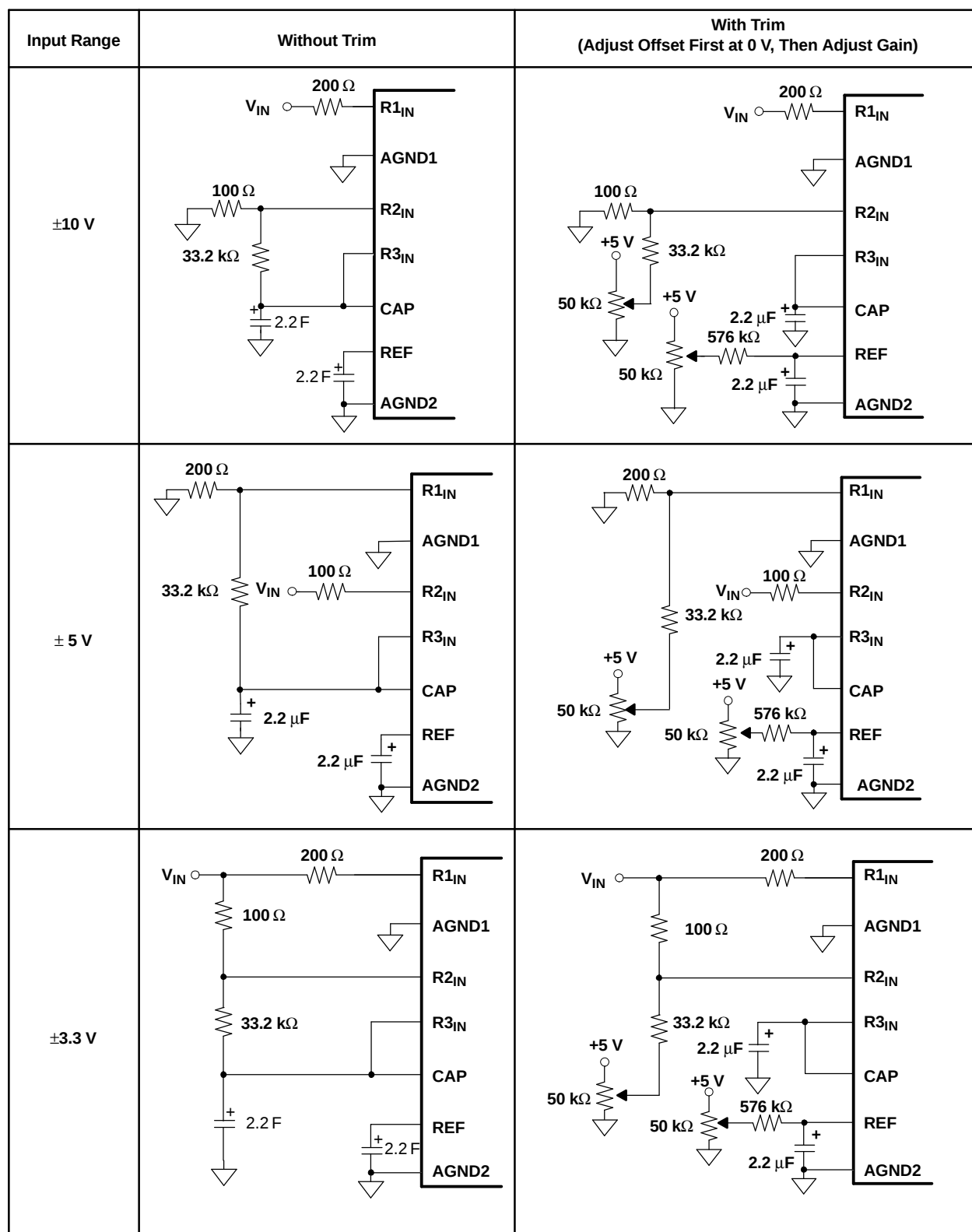


Figure 29. Offset/Gain Circuits for Bipolar Input Ranges

## PACKAGING INFORMATION

| Orderable part number        | Status<br>(1) | Material type<br>(2) | Package   Pins | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|------------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">ADS8508IBDW</a>  | Active        | Production           | SOIC (DW)   20 | 25   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | ADS8508IB           |
| ADS8508IBDW.A                | Active        | Production           | SOIC (DW)   20 | 25   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | ADS8508IB           |
| ADS8508IBDWG4                | Active        | Production           | SOIC (DW)   20 | 25   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | ADS8508IB           |
| ADS8508IBDWG4.A              | Active        | Production           | SOIC (DW)   20 | 25   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | ADS8508IB           |
| <a href="#">ADS8508IBDWR</a> | Active        | Production           | SOIC (DW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | ADS8508IB           |
| ADS8508IBDWR.A               | Active        | Production           | SOIC (DW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | ADS8508IB           |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| ADS8508IBDWR | SOIC         | DW              | 20   | 2000 | 330.0              | 24.4               | 10.8    | 13.3    | 2.7     | 12.0    | 24.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

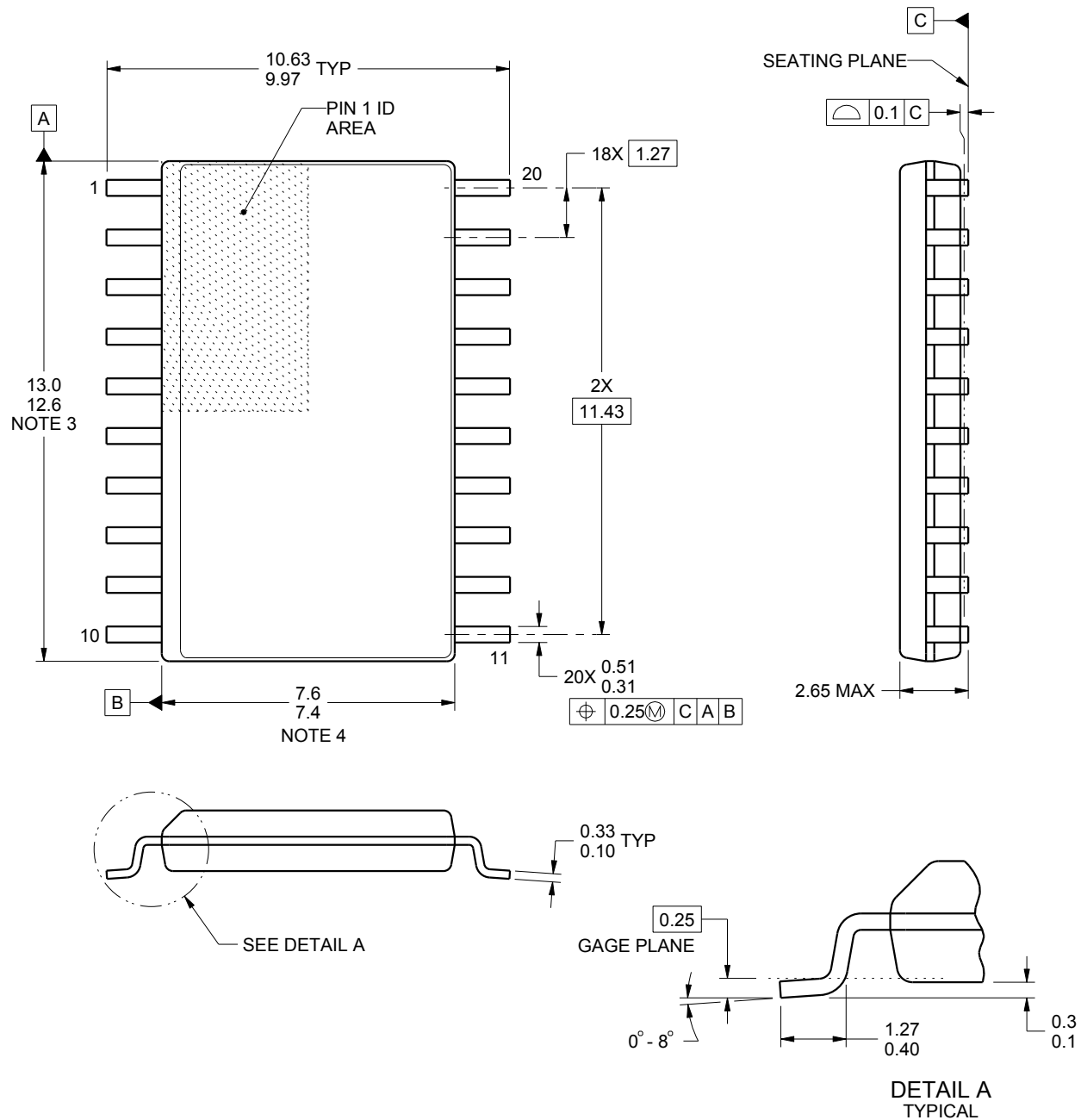
| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| ADS8508IBDWR | SOIC         | DW              | 20   | 2000 | 350.0       | 350.0      | 43.0        |

## TUBE



\*All dimensions are nominal

| Device          | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|-----------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| ADS8508IBDW     | DW           | SOIC         | 20   | 25  | 506.98 | 12.7   | 4826   | 6.6    |
| ADS8508IBDW.A   | DW           | SOIC         | 20   | 25  | 506.98 | 12.7   | 4826   | 6.6    |
| ADS8508IBDWG4   | DW           | SOIC         | 20   | 25  | 506.98 | 12.7   | 4826   | 6.6    |
| ADS8508IBDWG4.A | DW           | SOIC         | 20   | 25  | 506.98 | 12.7   | 4826   | 6.6    |



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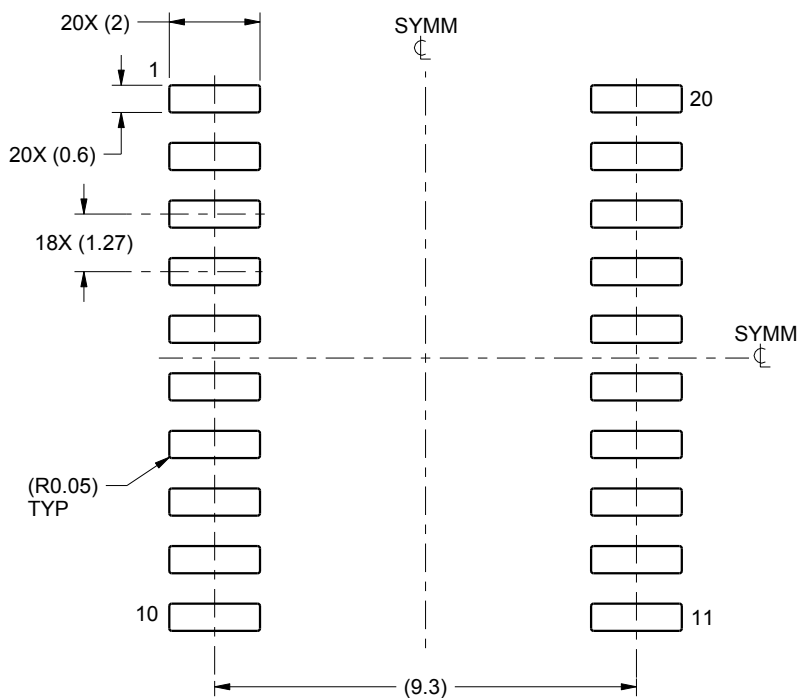
## NOTES:

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
5. Reference JEDEC registration MS-013.

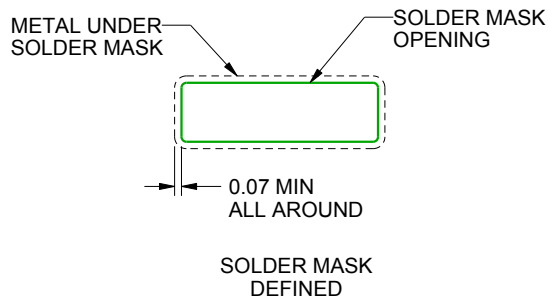
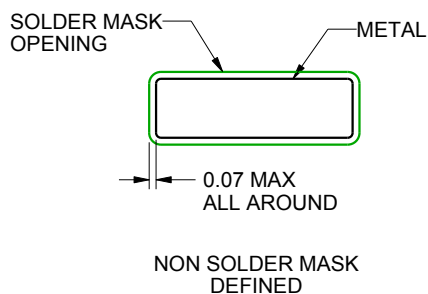
**DW0020A**

### SOIC - 2.65 mm max height

SOIC



LAND PATTERN EXAMPLE  
SCALE:6X



## SOLDER MASK DETAILS

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NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.  
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

DW0020A

SOIC - 2.65 mm max height

SOIC



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:6X

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NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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